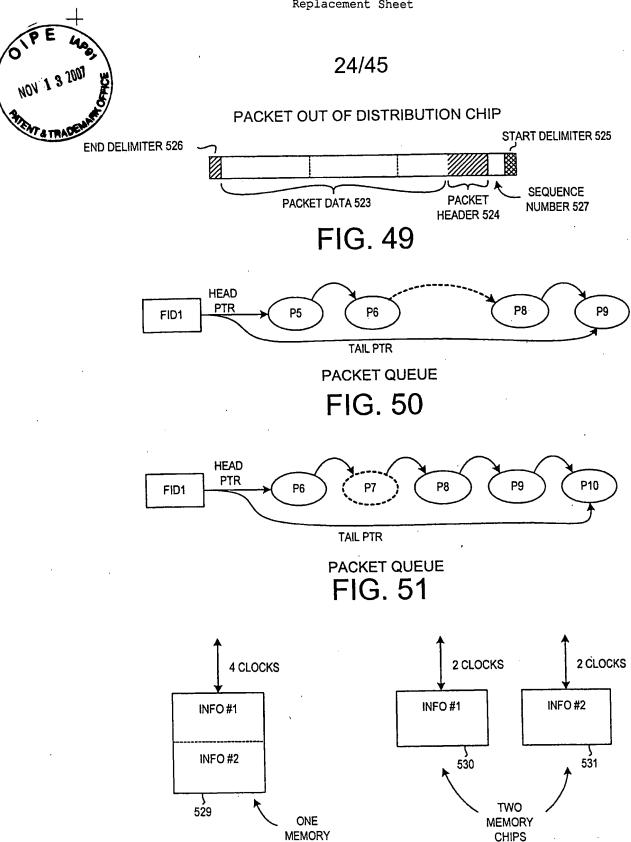
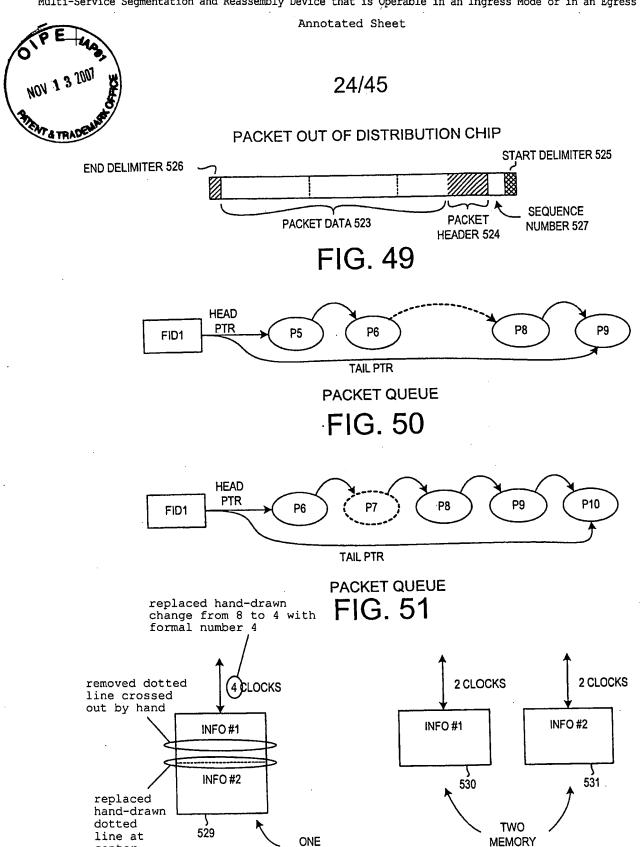
Multi-Service Segmentation and Reassembly Device that is Operable in an Ingress Mode or in an Egress Mode Replacement Sheet



CHIP

FIG. 52

Multi-Service Segmentation and Reassembly Device that is Operable in an Ingress Mode or in an Egress Mode



MEMORY

CHIP

center

of box

with formal dotted line

FIG. 52

CHIPS